

C0805C752MATACTU

Aliases (C0805C752MATAC7800)

SMD Comm X8G HT150C, Ceramic, 7,500 pF, 20%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0805, 0.7 mm



General Information		
Series	SMD Comm X8G HT150C	
Style	SMD Chip	
Description	SMD, MLCC, High Temperature, Ultra-Stable	
Features	High Temperature, Ultra-Stable	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Typical Component Weight	14 mg	
Shelf Life	78 Weeks	
MSL	1	

Dimensions		
Chip Size	0805	
L	2mm +/-0.2mm	
W	1.25mm +/-0.2mm	
Т	1.25mm +/-0.15mm	
S	0.7mm MIN	
В	0.5mm +/-0.25mm	

V V	1.2511111 1/ -0.211111
Т	1.25mm +/-0.15mm
S	0.7mm MIN
В	0.5mm +/-0.25mm
Packaging Specifications	

Specifications	
Capacitance	7,500 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	20%
Voltage DC	250 VDC
Dielectric Withstanding Voltage	625 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8G
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

Packaging	T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC
Packaging Quantity	2500	Applied (TCC) Dissipation Factor
		Aging Rate

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